



## 40V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

## Product Summary

BV <sub>DSS</sub>	Rds(on) Max	I <sub>D</sub> Tc = +25°С
40V	6.5mΩ @ V <sub>GS</sub> = 10V	85A
407	9.8mΩ @ V <sub>GS</sub> = 4.5V	70A

## **Description and Applications**

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize  $R_{DS(ON)}$  yet maintain superior switching performance.

PowerDI5060-8/SWP (Type UX)

- Notebook battery power managements
- DC-DC converters
- Load switches

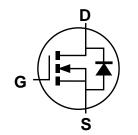


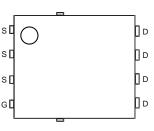
Top View

Bottom View

### Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Thermally Efficient Package Cooler Running Applications
  High Conversion Efficiency
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  Low RDS(ON) Minimizes On-State Losses
- Low RDS(ON) MINIMIZES On-State Losses
  Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications</li>
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  Load Free Finish, Paul Compliant (Nates 4, 8, 2)
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
  Halogen and Antimony Free. "Green" Device (Note 3)
- An automotive-compliant part is available under separate datasheet (DMTH4007LPSWQ)
- Mechanical Data
- Package: PowerDI<sup>®</sup>5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)





Internal Schematic

Top View Pin Configuration

# Ordering Information (Note 4)

Orderable Part Number	Paakara	Packing		
Orderable Part Number	Package	Qty.	Carrier	
DMTH4007LPSW-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

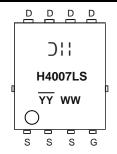
Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**





## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			Vdss	40	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 5)		T <sub>A</sub> = +25°C T <sub>A</sub> = +100°C	D	15 11	А
Continuous Drain Current, VGS = 10V (Note 6)	Steady State	Tc = +25°C Tc = +100°C	D	85 60	A
Maximum Continuous Body Diode Forward Current (Note 6)			ls	85	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			ldм	340	А
Avalanche Current, L = 0.1mH			I <sub>AS</sub>	20	А
Avalanche Energy, L = 0.1mH			Eas	20	mJ

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	2.7	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>0JA</sub>	55	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	83.3	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	1.8	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

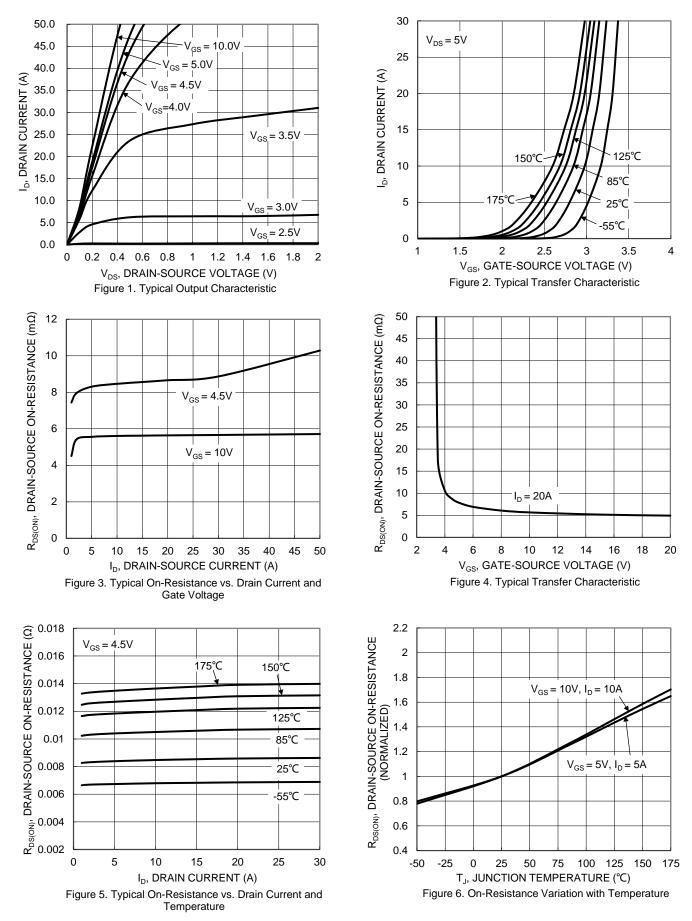
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	40	—	—	V	$V_{GS} = 0V, I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	—	—	1	μA	$V_{DS} = 32V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	—	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(th)	1	—	3	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Deserver	—	5.4	6.5	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	Rds(on)	—	8.4	9.8	11122	VGS = 4.5V, ID = 20A	
Diode Forward Voltage	V <sub>SD</sub>	—	—	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	1,895	—		V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V, f = 1MHz	
Output Capacitance	Coss		485	_	pF		
Reverse Transfer Capacitance	Crss	_	20.9	—			
Gate Resistance	Rg		0.62	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	12.4	—		V <sub>DS</sub> = 30V, I <sub>D</sub> = 20A	
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	29.1	_	nC		
Gate-Source Charge	Q <sub>gs</sub>	_	5.9	_	nc		
Gate-Drain Charge	Q <sub>gd</sub>	_	3.5	_			
Turn-On Delay Time	tD(ON)		5.4	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_D = 20A, R_G = 3\Omega$	
Turn-On Rise Time	tR		4.5	_			
Turn-Off Delay Time	tD(OFF)		16.2	_	ns		
Turn-Off Fall Time	tF		3.5	_			
Body Diode Reverse Recovery Time	trr		30.6	_	ns		
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	28.1	—	nC	I <sub>F</sub> = 20A, di/dt = 100A/µs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:



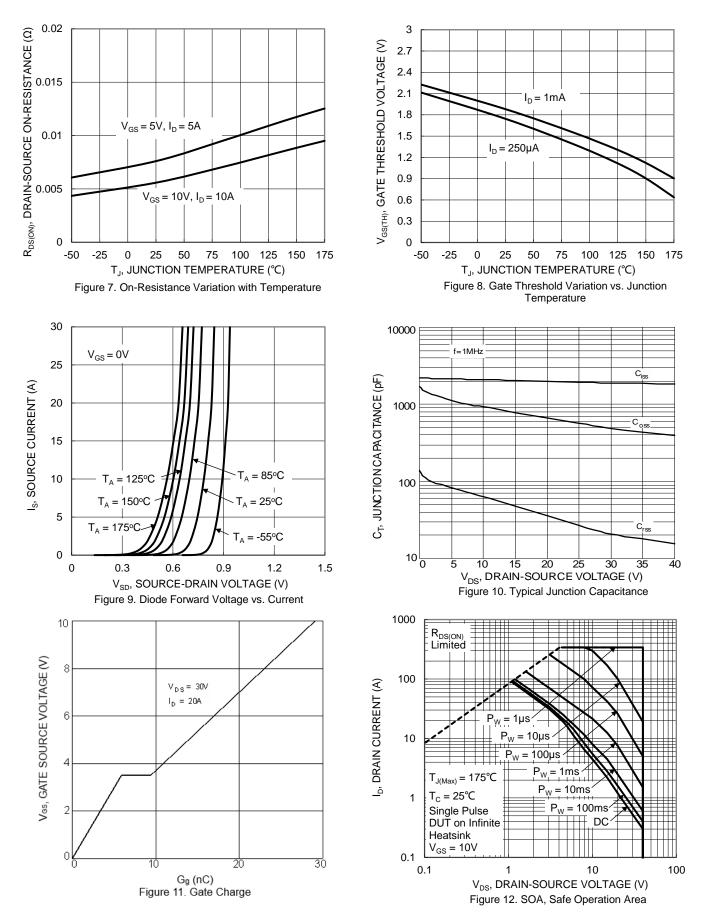
# DMTH4007LPSW



DMTH4007LPSW Document number: DS46749 Rev. 1 - 2



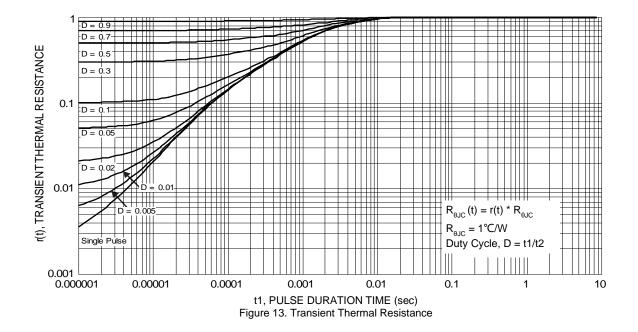
# DMTH4007LPSW



DMTH4007LPSW Document number: DS46749 Rev. 1 - 2 4 of 7 www.diodes.com



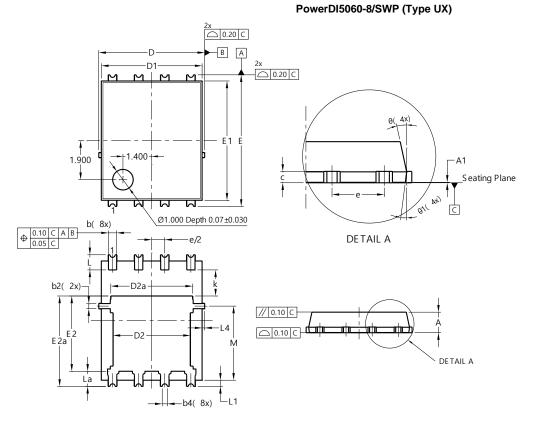






## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

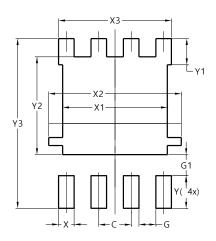


Po	PowerDI5060-8/SWP							
	(Type UX)							
Dim	Min	Max	Тур					
Α	0.90	1.10	1.00					
A1	0	0.05						
b	0.30	0.50	0.41					
b2	0.20	0.35	0.25					
b4	(	).25REF	-					
С	0.230	0.330	0.277					
D	5	.15 BS0	C (					
D1	4.70	5.10	4.90					
D2	3.56	3.96	3.76					
D2a	3.78	4.18	3.98					
E	6	.40 BS0	0					
E1	5.60	6.00	5.80					
E2	3.46	3.86	3.66					
E2a	4.195	4.595	4.395					
е	1	.27BSC	<u>, , , , , , , , , , , , , , , , , , , </u>					
k	1.05							
L	0.635	0.835	0.735					
La	0.635	0.835	0.735					
L1	0.200	0.400	0.300					
L4	0.025	0.225	0.125					
М	3.205	4.005	3.605					
θ	10°	12°	11°					
θ1	6°	8°	7°					
All	All Dimensions in mm							

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	5.190		
X3	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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